

ICPIE 2018

www.icpie.org

October 27-29, 2018

Chengdu, China

2018 the International Conference on
Product and Industrial Engineering

Submission Deadline: July 5, 2018



ICPIE 2018 is a platform for researchers, engineers, academicians as well as industrial professionals from all over the world to present their research results and development activities in Advances in product and industrial engineering.

PUBLICATION

After a careful reviewing process, all accepted papers after proper registration and presentation, will be published in the Conference Proceedings, and sent to be submitted by **Ei Compendex** and **Scopus**.

IMPORTANT DATE

Submission Deadline: July 5, 2018

Notification Date: July 20, 2018

Registration Deadline: August 10, 2018

SUBMISSION METHOD

Full Paper (publication and oral presentation)

Abstract (oral presentation only)

Electronic Submission System (.pdf)

<http://www.easychair.org/conferences/?conf=icpie2018>

Via email: icpie@zhconf.ac.cn

CALL FOR PAPER

- Industrial design
- Industrial Tribology
- Machine Design
- Machinery and Machine Design
- Manufacturing system and simulation
- Mechanical Engineering
- Mechanical Power Engineering
- Nano fabrication and precision engineering
- Optimization of Systems
- Rapid Prototyping
- Refrigeration and air conditioning
- Ship Designing and Building
- Solid and Fracture Mechanics
- Solid Mechanics
- Surface mount and packaging technology
- Tribology and Reverse Engineering
- Micro-Machining

More Topics:

<http://icpie.org/cfp.html>

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